

LBSS84WT1G

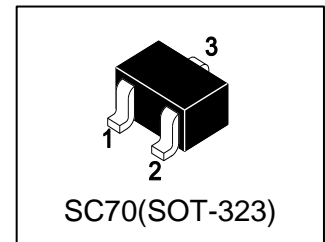
S-LBSS84WT1G

Power MOSFET

130 mAmps, 50 Volts P-Channel SC-70

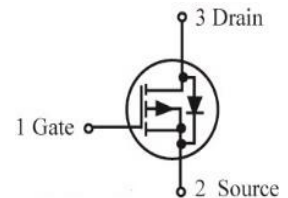
1. FEATURES

- We declare that the material of product compliance with RoHS requirements and Halogen Free.
- S- prefix for automotive and other applications requiring unique site and control change requirements; AEC-Q101 qualified and PPAP capable.
- Energy efficient



2. DEVICE MARKING AND ORDERING INFORMATION

| Device | Marking | Shipping |
|------------|---------|-----------------|
| LBSS84WT1G | PD | 3000/Tape&Reel |
| LBSS84WT3G | PD | 10000/Tape&Reel |



3. MAXIMUM RATINGS(Ta = 25°C)

| Parameter | Symbol | Limits | Unit |
|-------------------------------------|--------|--------|------|
| Drain-Source Voltage | VDSS | -50 | Vdc |
| Gate-to-Source Voltage – Continuous | VGS | ±20 | Vdc |
| Drain Current | | | mAdc |
| – Continuous TA = 25°C | ID | -130 | |
| – Pulsed (tp ≤ 10µs) | IDM | -520 | |

4. THERMAL CHARACTERISTICS

| Parameter | Symbol | Limits | Unit |
|---|----------|------------|-------------|
| Total Device Dissipation, FR-5 Board (Note 1) @ TA = 25°C Derate above 25°C | PD | 225 1.8 | mW mW/°C |
| Thermal Resistance, Junction-to-Ambient(Note 1) | RθJA | 556 | °C/W |
| Junction and Storage temperature | TJ, Tstg | -55~+150 | °C |
| Maximum Lead Temperature for Soldering Purposes, for 10 seconds | TL | 260 | °C |

1. FR-5 = 1.0×0.75×0.062 in.

5. ELECTRICAL CHARACTERISTICS (Ta= 25°C)
OFF CHARACTERISTICS

| Characteristic | Symbol | Min. | Typ. | Max. | Unit |
|---|--------|------|------|--------------------|-----------|
| Drain–Source Breakdown Voltage (VGS = 0, ID = -250 μ Adc) | VBRDSS | -50 | - | - | Vdc |
| Zero Gate Voltage Drain Current (VGS = 0, VDS = -25 Vdc) (VGS = 0, VDS = -50 Vdc) (VGS = 0, VDS = -50 Vdc, TJ=125°C) | IDSS | - | - | -0.1 -15 -60 | μ Adc |
| Gate–Body Leakage Current, Forward (VGS = 20 Vdc) | IGSSF | - | - | 10 | μ Adc |
| Gate–Body Leakage Current, Reverse (VGS = - 20 Vdc) | IGSSR | - | - | -10 | μ Adc |

ON CHARACTERISTICS (Note 2)

| | | | | | |
|---|---------|------|---|----|------|
| Gate Threshold Voltage (VDS = VGS, ID = -250 μ Adc) | VGS(th) | -0.8 | - | -2 | Vdc |
| Static Drain–Source On–State Resistance (VGS = -5.0 Vdc, ID = -100 mAdc) | RDS(on) | - | 5 | 10 | Ohms |
| Transfer Admittance (VDS = -25 Vdc, ID = -100 mAdc, f = 1.0 kHz) | yfs | 50 | - | - | mS |

DYNAMIC CHARACTERISTICS

| | | | | | |
|--|------|---|----|---|----|
| Input Capacitance (VDS = -5.0 Vdc) | Ciss | - | 30 | - | pF |
| Output Capacitance (VDS = -5.0 Vdc) | Coss | - | 10 | - | pF |
| Reverse Transfer Capacitance (VDS = -5.0 Vdc) | Ciss | - | 5 | - | pF |

SWITCHING CHARACTERISTICS

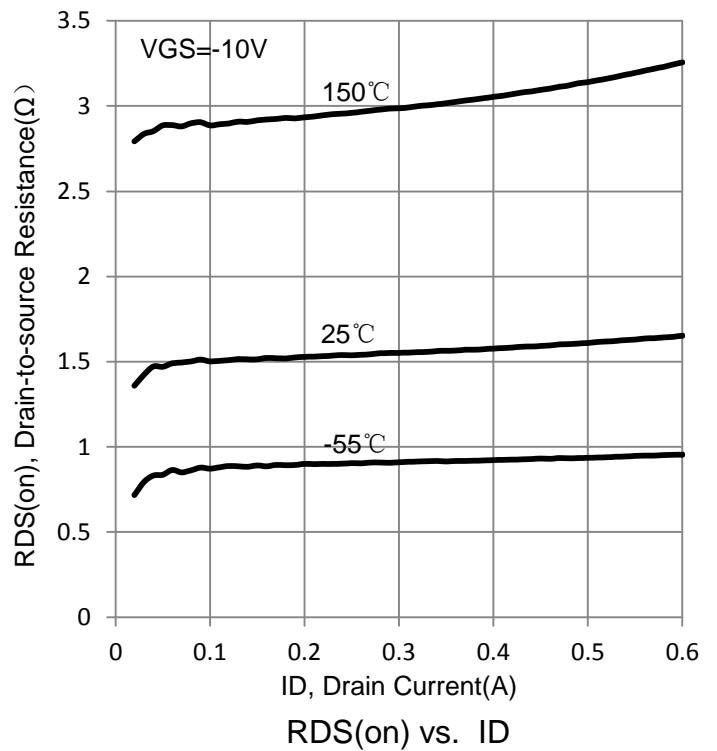
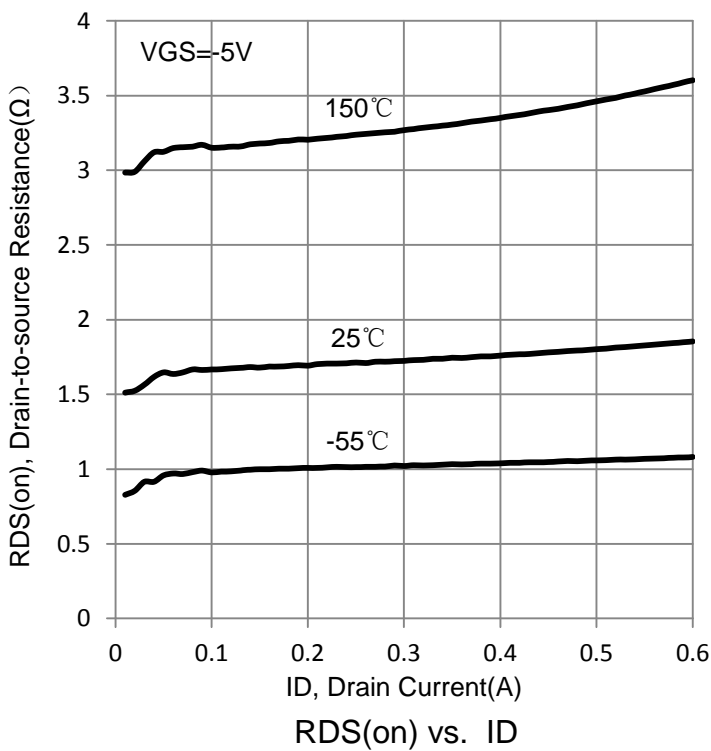
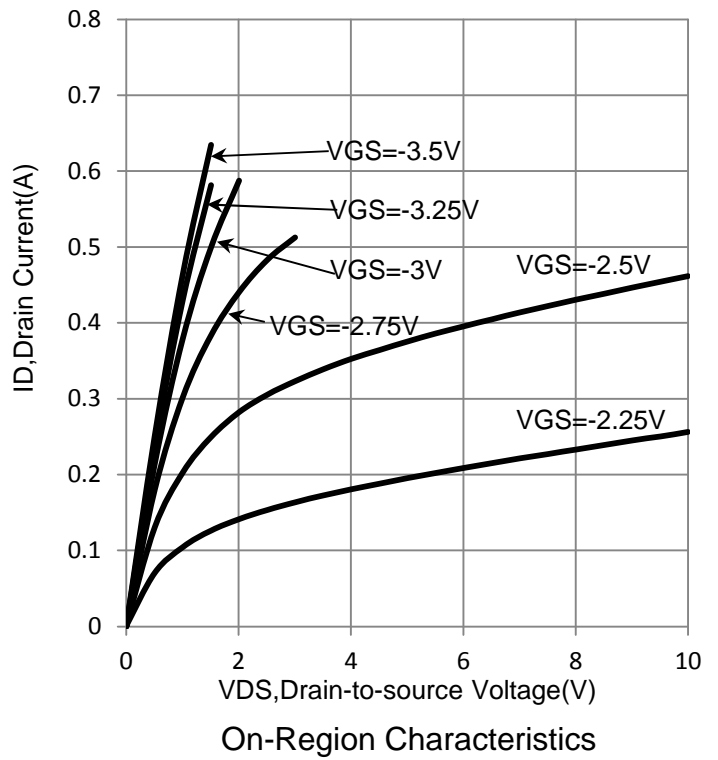
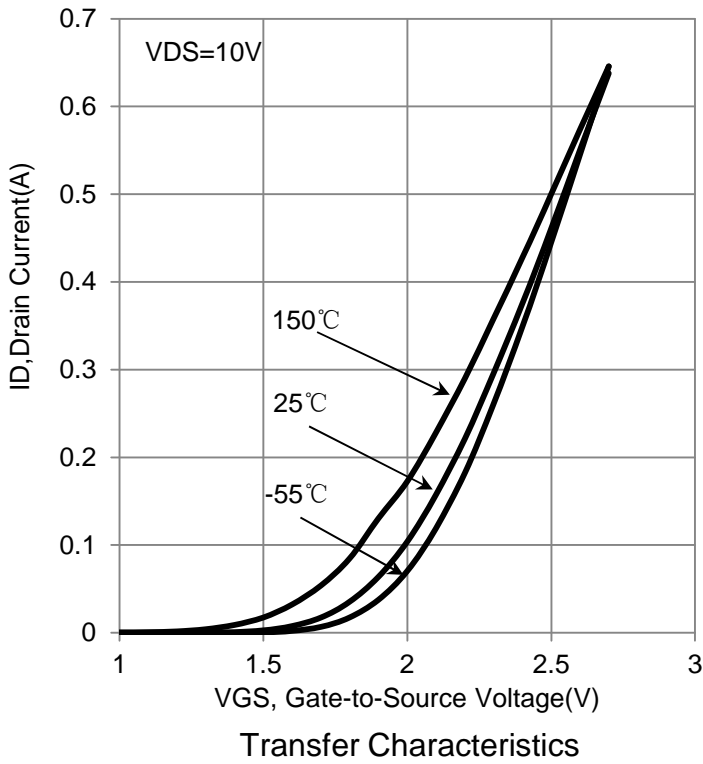
| | | | | | | |
|---------------------|---|---------|---|-----|---|----|
| Turn-On Delay Time | (VDD = -15 Vdc, ID = -2.5 Adc, RL = 50 Ω) | td(on) | - | 2.5 | - | ns |
| Rise Time | | tr | - | 1 | - | |
| Turn-Off Delay Time | | td(off) | - | 16 | - | |
| Fall Time | | tf | - | 8 | - | |

SOURCE–DRAIN DIODE CHARACTERISTICS

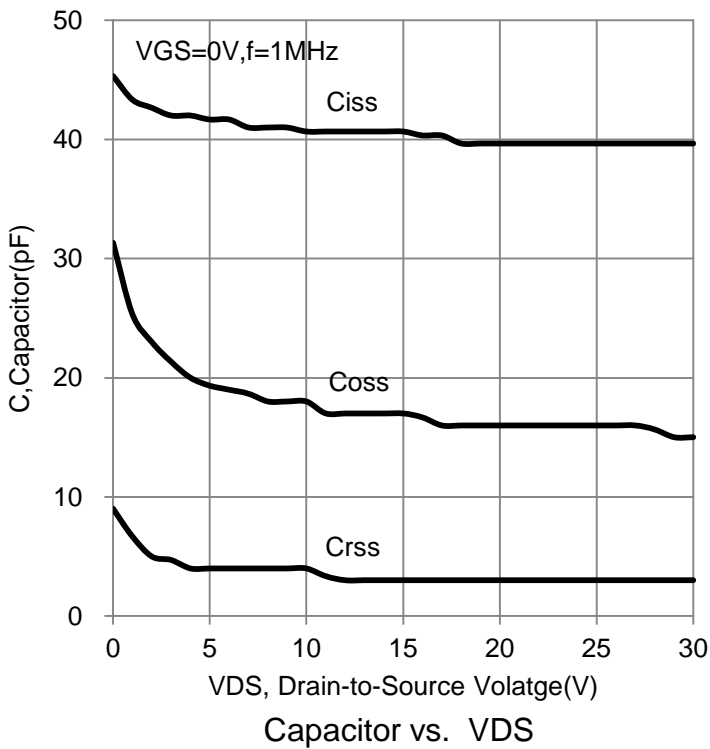
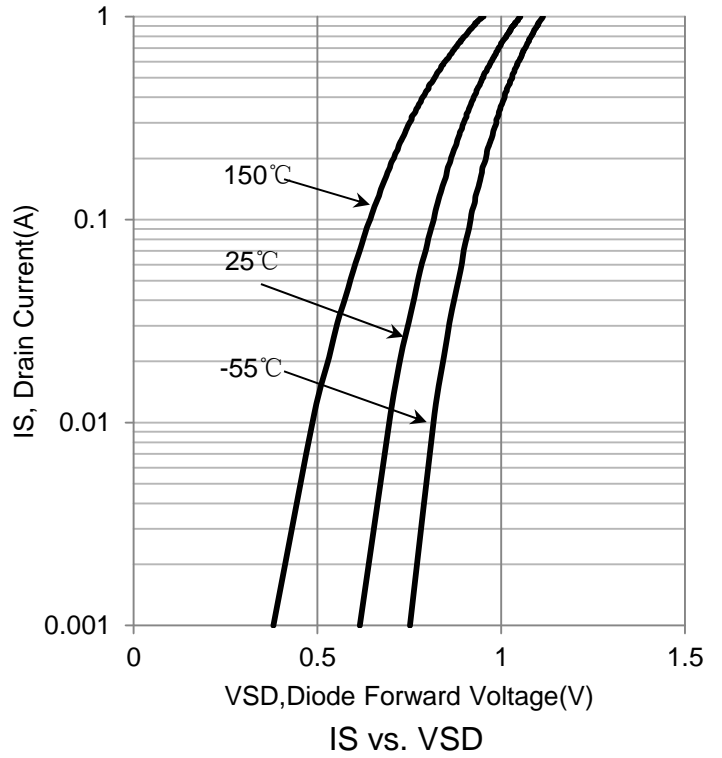
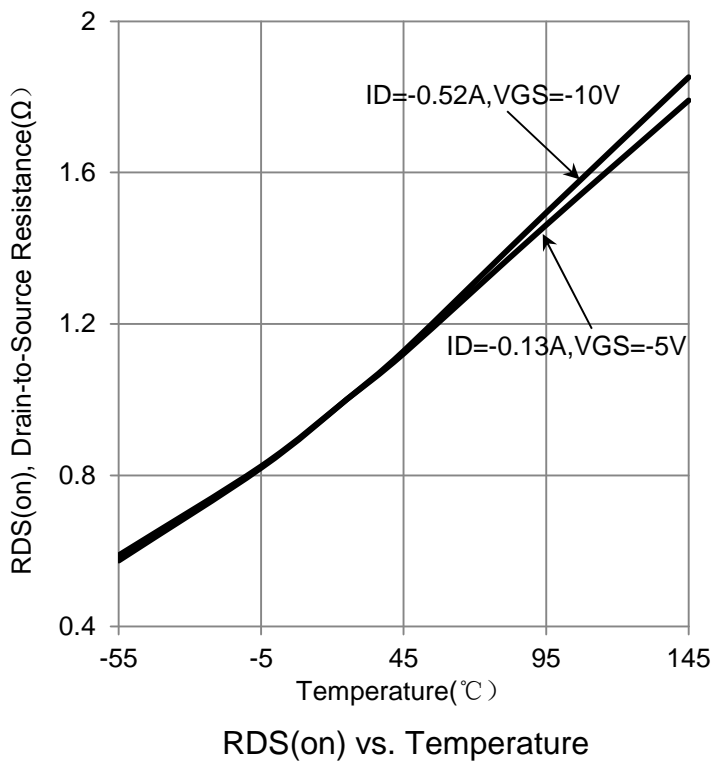
| | | | | | |
|--------------------|-----|---|------|-------|---|
| Continuous Current | IS | - | - | -0.13 | A |
| Pulsed Current | ISM | - | - | -0.52 | A |
| Forward Voltage | VSD | - | -2.5 | - | V |

2.Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

6. ELECTRICAL CHARACTERISTICS CURVES



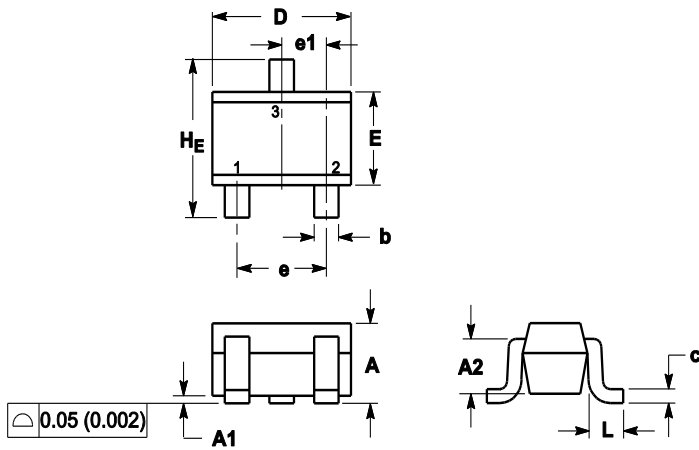
6. ELECTRICAL CHARACTERISTICS CURVES(Con.)



7. OUTLINE AND DIMENSIONS

Notes:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.



| DIM | MILLIMETERS | | | INCHES | | |
|----------------|-------------|------|------|----------|-------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 0.80 | 0.90 | 1.00 | 0.032 | 0.035 | 0.039 |
| A1 | 0.00 | 0.05 | 0.10 | 0.000 | 0.002 | 0.004 |
| A2 | 0.70REF | | | 0.028REF | | |
| b | 0.30 | 0.35 | 0.40 | 0.012 | 0.014 | 0.016 |
| c | 0.10 | 0.18 | 0.25 | 0.004 | 0.007 | 0.010 |
| D | 1.80 | 2.10 | 2.20 | 0.071 | 0.083 | 0.087 |
| E | 1.15 | 1.24 | 1.35 | 0.045 | 0.049 | 0.053 |
| e | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 |
| e1 | 0.65REF | | | 0.026REF | | |
| L | 0.20 | 0.38 | 0.56 | 0.008 | 0.015 | 0.022 |
| H _E | 2.00 | 2.10 | 2.40 | 0.079 | 0.083 | 0.095 |

8. SOLDERING FOOTPRINT

